



# PESD4V0X1BESF

Very low capacitance bidirectional ESD protection diode

2 March 2021

Product data sheet

## 1. General description

Very low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode, part of the TrEOS protection family. The device is housed in a DSN0603-2 (SOD962-2) leadless ultra small Surface-Mounted Device (SMD) package designed to protect one signal line from the damage caused by ESD and other transients.

## 2. Features and benefits

- Bidirectional ESD protection of one line
- Extremely low diode capacitance  $C_d = 0.9$  pF
- Extremely low clamping to protect sensitive I/Os
- Extremely low inductance protection path to ground
- ESD protection up to  $\pm 30$  kV according to IEC 61000-4-2
- Surge robustness  $I_{PPM} = 15$  A according to IEC 61000-4-5
- Ultra small SMD package

## 3. Applications

- Cellular handsets and accessories
- Portable electronics
- Communication systems
- Computers and peripherals

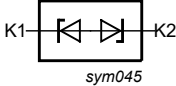
## 4. Quick reference data

Table 1. Quick reference data

| Symbol    | Parameter                | Conditions                                  | Min | Typ | Max | Unit |
|-----------|--------------------------|---------------------------------------------|-----|-----|-----|------|
| $V_{RWM}$ | reverse standoff voltage |                                             | -   | -   | 4   | V    |
| $C_d$     | diode capacitance        | $f = 1$ MHz; $V_R = 0$ V; $T_{amb} = 25$ °C | -   | -   | 0.9 | pF   |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description       | Simplified outline                                                                                                                          | Graphic symbol                                                                                       |
|-----|--------|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|
| 1   | K1     | cathode (diode 1) | <br>Transparent<br>top view<br><b>DSN0603-2 (SOD962-2)</b> | <br><i>sym045</i> |
| 2   | K2     | cathode (diode 2) |                                                                                                                                             |                                                                                                      |

6. Ordering information

Table 3. Ordering information

| Type number   | Package   |                                                                                                 |          |
|---------------|-----------|-------------------------------------------------------------------------------------------------|----------|
|               | Name      | Description                                                                                     | Version  |
| PESD4V0X1BESF | DSN0603-2 | silicon, leadless ultra small package; 2 terminals; 0.4 mm pitch; 0.6 mm x 0.3 mm x 0.3 mm body | SOD962-2 |

7. Marking

Table 4. Marking codes

| Type number   | Marking code |
|---------------|--------------|
| PESD4V0X1BESF | C4           |

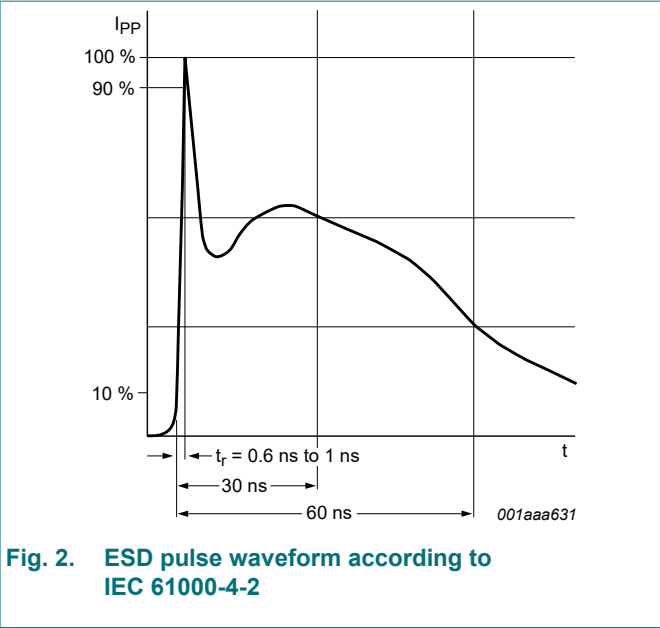
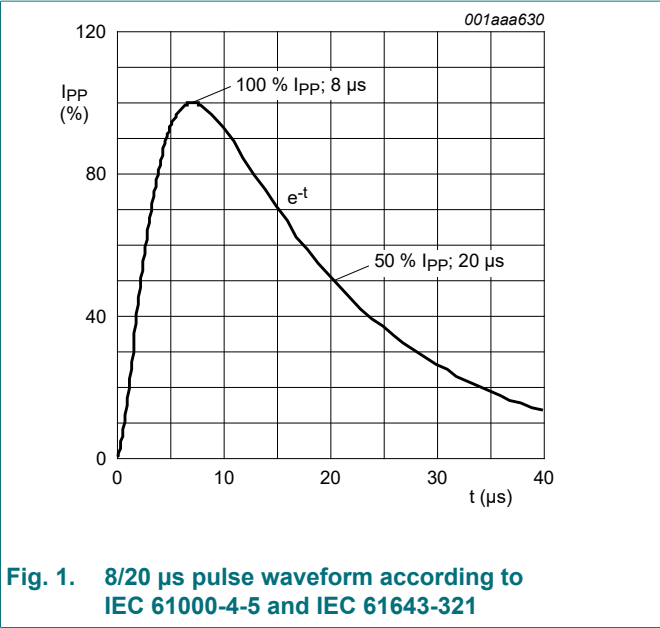
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol              | Parameter                       | Conditions                       |         | Min | Max | Unit |
|---------------------|---------------------------------|----------------------------------|---------|-----|-----|------|
| V <sub>RWM</sub>    | reverse standoff voltage        |                                  |         | -   | 4   | V    |
| I <sub>PPM</sub>    | rated peak pulse current        | t <sub>p</sub> = 8/20 μs         | [1] [2] | -   | 15  | A    |
| T <sub>amb</sub>    | ambient temperature             |                                  |         | -40 | 125 | °C   |
| T <sub>stg</sub>    | storage temperature             |                                  |         | -65 | 150 | °C   |
| ESD maximum ratings |                                 |                                  |         |     |     |      |
| V <sub>ESD</sub>    | electrostatic discharge voltage | IEC 61000-4-2; contact discharge | [3]     | -30 | 30  | kV   |
|                     |                                 | IEC 61000-4-2; air discharge     | [3]     | -30 | 30  | kV   |

- [1] Device stressed with 8/20 μs exponential decay waveform according to IEC 61000-4-5.
- [2] In positive and negative direction.
- [3] Device stressed with ten non-repetitive ESD pulses.



9. Characteristics

Table 6. Characteristics  
*t<sub>amb</sub> = 25°C unless otherwise specified.*

| Symbol           | Parameter               | Conditions                                                |     | Min | Typ  | Max | Unit |
|------------------|-------------------------|-----------------------------------------------------------|-----|-----|------|-----|------|
| V <sub>BR</sub>  | breakdown voltage       | I <sub>R</sub> = 1 mA                                     |     | -   | 6.8  | -   | V    |
| I <sub>RM</sub>  | reverse leakage current | V <sub>RWM</sub> = 4 V; T <sub>amb</sub> = 25 °C          | [1] | -   | 1    | 50  | nA   |
| C <sub>d</sub>   | diode capacitance       | f = 1 MHz; V <sub>R</sub> = 0 V; T <sub>amb</sub> = 25 °C |     | -   | -    | 0.9 | pF   |
|                  |                         | f = 1 MHz; V <sub>R</sub> = 1.5 V                         |     | -   | -    | 0.9 | pF   |
| V <sub>CL</sub>  | clamping voltage        | I <sub>PPM</sub> = 4 A                                    | [2] | -   | 3.1  | -   | V    |
|                  |                         | I <sub>PPM</sub> = 15 A                                   | [2] | -   | 4.8  | -   | V    |
| R <sub>dyn</sub> | dynamic resistance      | I <sub>R</sub> = 10 A                                     | [3] | -   | 0.11 | -   | Ω    |
|                  |                         | I <sub>R</sub> = -10 A                                    | [3] | -   | 0.11 | -   | Ω    |

[1] Guaranteed by design.  
[2] Device stressed with 8/20  $\mu$ s exponential decay waveform according to IEC 61000-4-5.  
[3] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.1-2008.

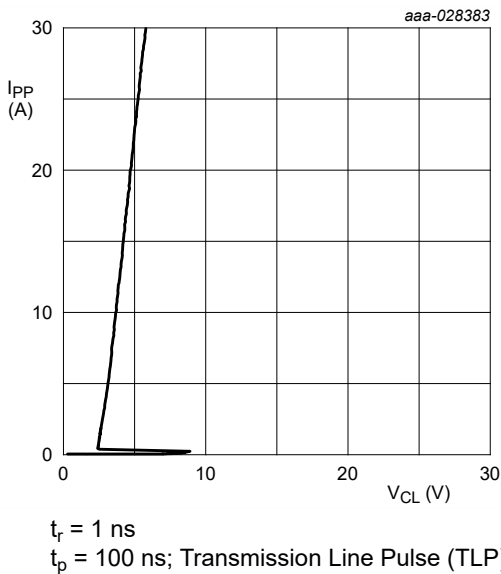


Fig. 3. Dynamic resistance with positive clamping; typical values

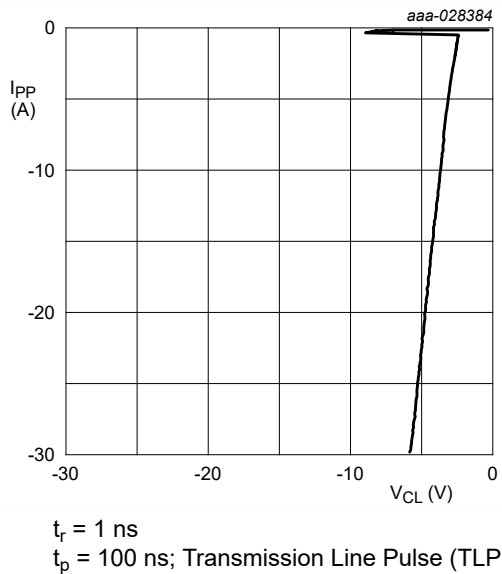


Fig. 4. Dynamic resistance with negative clamping; typical values

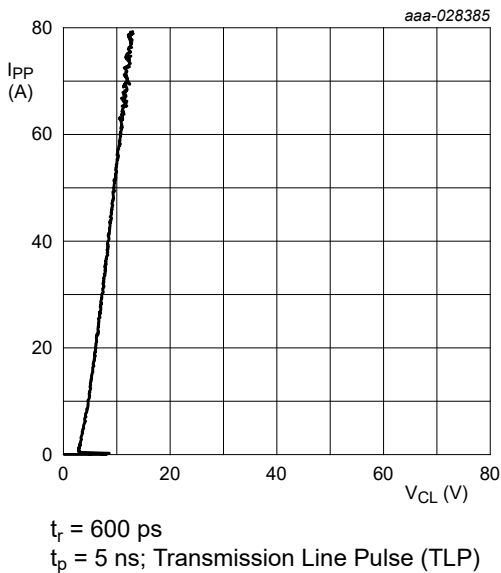


Fig. 5. Dynamic resistance with positive clamping; typical values

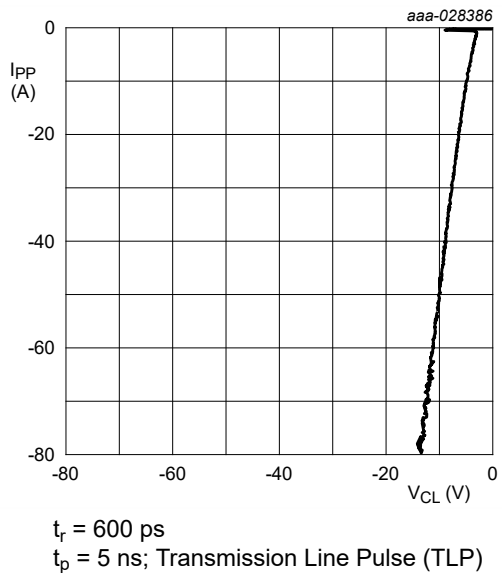
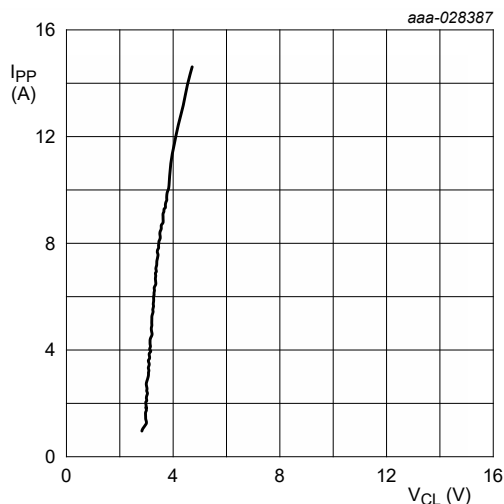
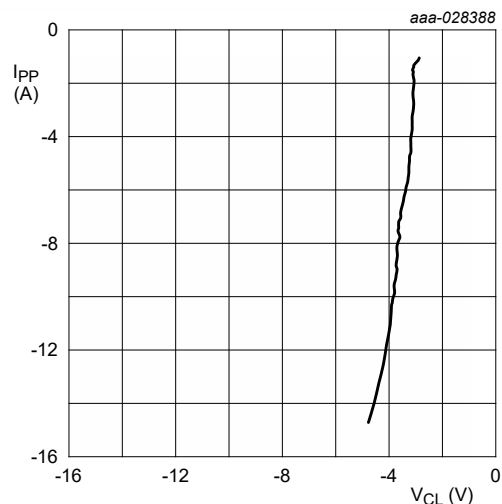


Fig. 6. Dynamic resistance with negative clamping; typical values



IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; positive pulse

**Fig. 7. Dynamic resistance with positive clamping; typical values**



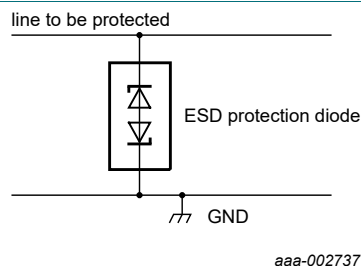
IEC 61000-4-5;  $t_p = 8/20 \mu s$ ; negative pulse

**Fig. 8. Dynamic resistance with negative clamping; typical values**

## 10. Application information

The device is designed for the protection of one bidirectional data line from surge pulses and ESD damage. The device is suitable on lines where the signal polarities are both positive and negative with respect to ground.

The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).



aaa-002737

**Fig. 9. Application diagram**

### Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the device as close to the input terminal or connector as possible.
2. Minimize the path length between the device and the protected line.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

11. Package outline

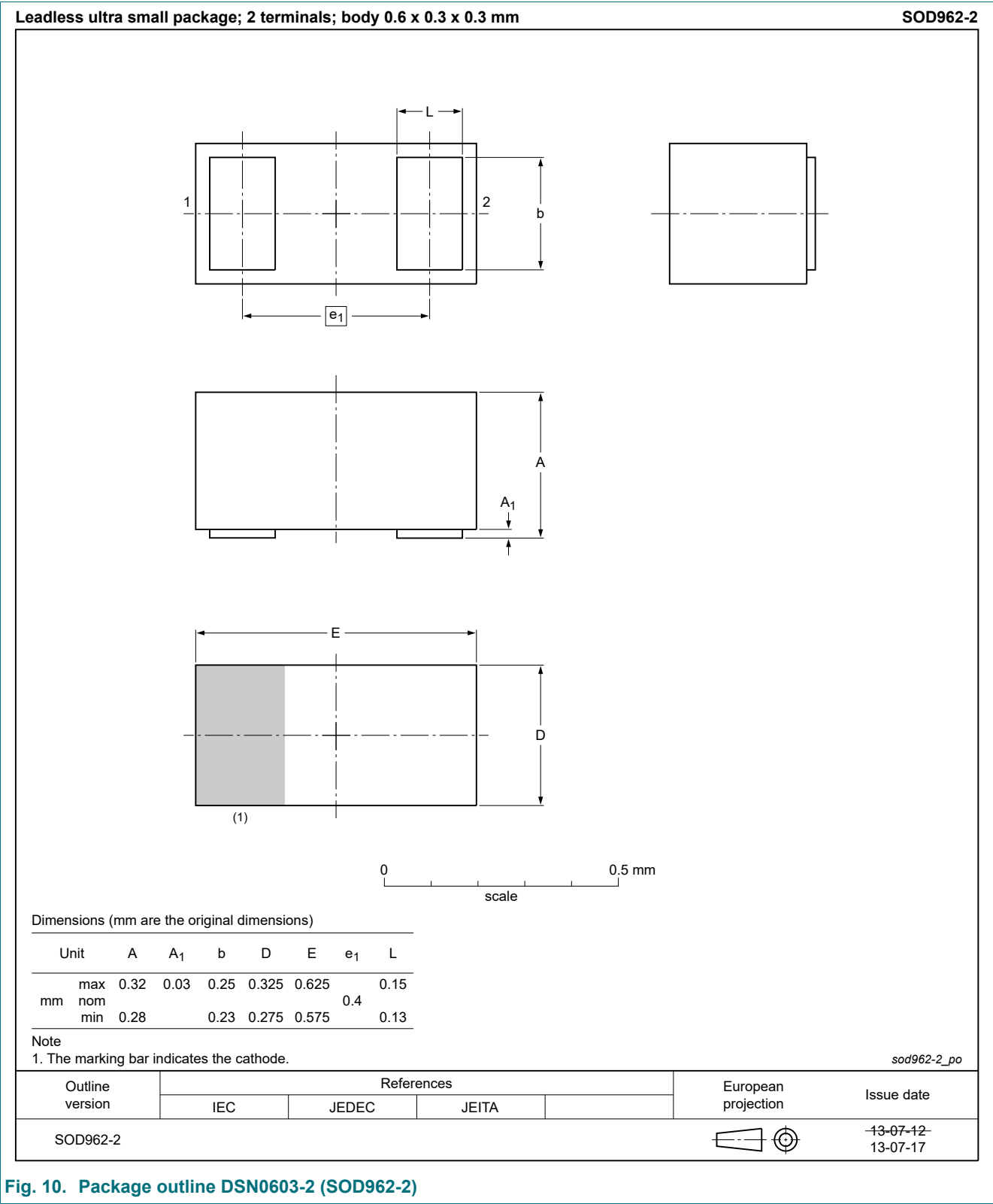


Fig. 10. Package outline DSN0603-2 (SOD962-2)

12. Soldering

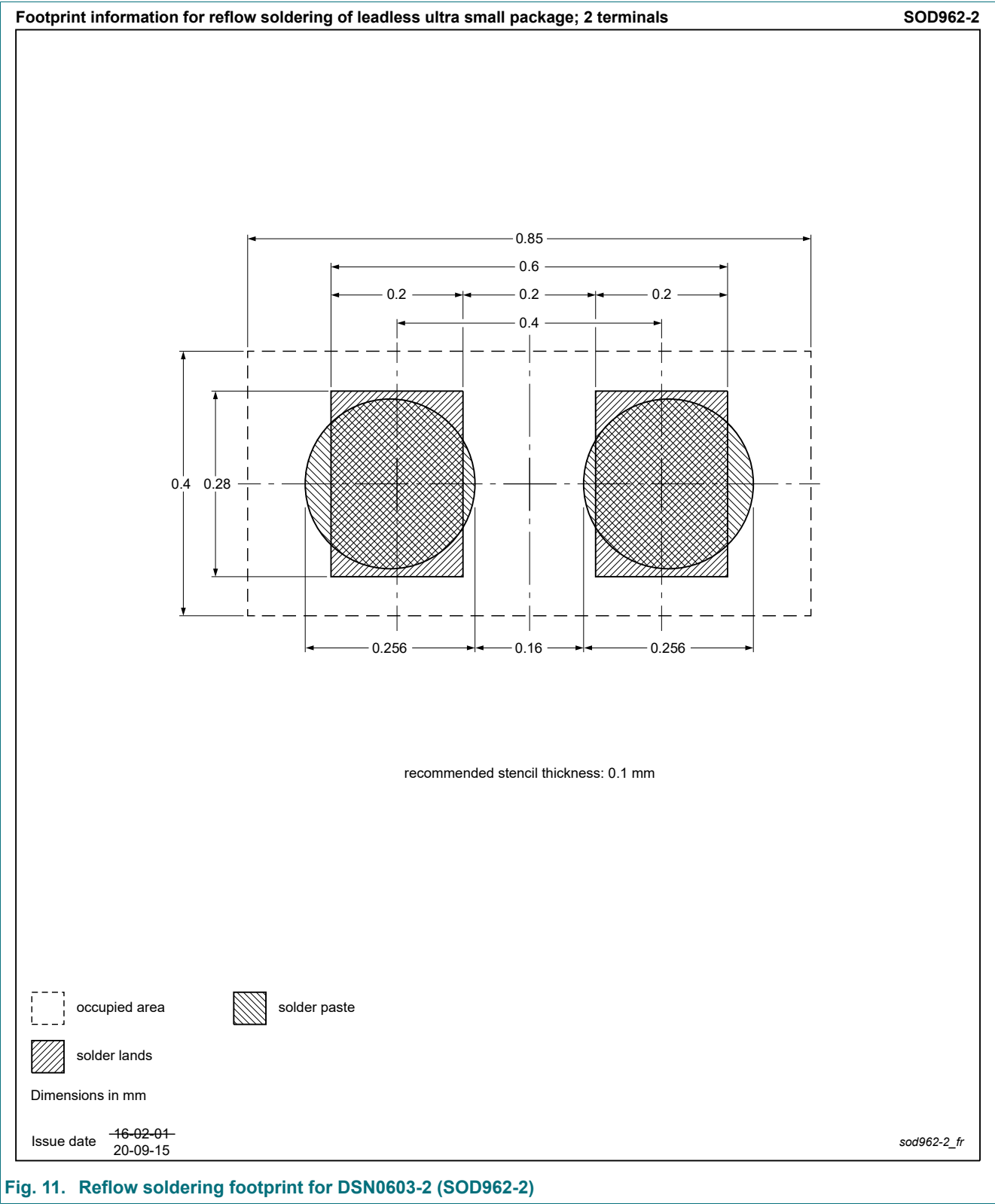


Fig. 11. Reflow soldering footprint for DSN0603-2 (SOD962-2)

13. Revision history

Table 7. Revision history

| Data sheet ID     | Release date                                                                                | Data sheet status  | Change notice | Supersedes        |
|-------------------|---------------------------------------------------------------------------------------------|--------------------|---------------|-------------------|
| PESD4V0X1BESF v.2 | 20210302                                                                                    | Product data sheet | -             | PESD4V0X1BESF v.1 |
| Modifications:    | <ul style="list-style-type: none"><li>Figure "Reflow soldering footprint" updated</li></ul> |                    |               |                   |
| PESD4V0X1BESF v.1 | 20190822                                                                                    | Product data sheet | -             | -                 |

## 14. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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